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CONFIRMATION NO. 3741

FILING RECEIPT

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MARSHALL GERSTEIN

Date Mailed: 09/12/2003

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11

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Non-Publication Request: No

Early Publication Request: No

Title

CMP slurry compositions for oxide films and methods for forming metal line contact plugs using the same ✓

30205/39380

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The Patent Office is hereby requested to acknowledge receipt
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WITH SERIAL NO. AND FILING DATE:

JUNG et al.

"SMP slurry compositions for oxide films and methods for....."

Patent Application Transmittal under 37 C.F.R. §1.53 (& copy)

Title Page, Specification 10 pages; Claims 4 Pages;

Abstract; Drawings 7 pages, Executed Declaration,

Information Disclosure Statement w/form PTO-1449

(PTO/SB/08A) with: 2U, & Transmittal of Priority Document

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